

**Amendments to the Claims:**

This listing of claims will replace all prior versions, and listings, of claims in the application:

**Listing of Claims:**

1. (Currently amended) A ~~dry-etching method for fabricating a substrate,~~  
producing a solar cell comprising:

placing the ~~a~~ substrate for a solar cell on an RF electrode in a chamber;

placing a plate to cover the substrate, the plate being provided with a number of opening portions in a central region thereof and a number of opening portions in a peripheral region surrounding the central region thereof, an open area ratio of the opening portions in the peripheral region being smaller than an open area ratio of the opening portions in the central region; and

forming fine textures on a surface of the substrate by using residues being chiefly composed of components of the substrate as an etching mask as an etching mask.

2. (Currently amended) The ~~dry-etching method~~ for producing a solar cell according to Claim 1, wherein:

the plate is placed to be spaced apart from the surface of the substrate by 5 to 30 mm.

3. (Currently amended) The ~~dry-etching method~~ for producing a solar cell according to Claim 1, wherein:

the substrate is a plate or a film member made of one material selected from silicon, glass, metal, plastic, and resin.

4. (Currently amended) The ~~dry-etching method~~ for producing a solar cell according to Claim 1, wherein:

the ~~dry-etching method is~~ fine textures are fabricated by a reactive ion etching method.

5-7. (Canceled)

8. (Currently amended) A ~~dry-etching method for fabricating a substrate,~~ producing a solar cell comprising:

placing the a substrate for a solar cell on an RF electrode in a chamber;

placing a plate to cover the substrate while securing a distance from the surface of said substrate, the plate being provided with a number of opening portions, each opening portion being of a size such that allows a virtual column having a diameter equal to or less than half (1/2) the distance to pass through the opening portion while inhibiting a virtual column having a diameter greater than half the distance from passing through the opening portion; and

forming fine textures on a surface of the substrate by using residues being chiefly composed of components of the substrate as an etching mask as an etching mask.

9. (Currently amended) The ~~dry-etching method~~ for producing a solar cell according to Claim 8, wherein:

the plate is placed to be spaced apart from the surface of the substrate by 5 to 30 mm.

10. (Currently amended) The ~~dry-etching method for producing a solar cell~~ according to Claim 8, wherein:

~~the dry-etching method is~~ fine textures are fabricated by a reactive ion etching method.

11-14. (Canceled)

15. (Currently amended) A ~~dry-etching method for fabricating a substrate producing a solar cell~~ comprising:

placing the a substrate for a solar cell on an RF electrode in a chamber;

placing a plate to cover the substrate, said plate being provided with a number of opening portions, chamfered portions being provided to the top ~~and/or~~ and bottom corners or to the bottom corners of the opening portions;

forming fine textures on a surface of the substrate by using residues being chiefly composed of components of the substrate as an etching mask as an etching mask.

16-20. (Canceled)

21. (Currently amended) A ~~dry-etching method for fabricating a substrate, producing a solar cell~~ comprising:

placing the a substrate for a solar cell on an RF electrode in a chamber;

placing a plate to cover the substrate, the plate being provided with a number of opening portions in a central region thereof and a number of opening portions in a peripheral region surrounding the central region thereof, an open area ratio of the opening portions in the peripheral region being smaller than an open area ratio of the opening portions in the central region;

wherein a number of ~~compounds~~ residues are formed by an etching of the substrate during an RF power applying, wherein the ~~compounds~~ residues are trapped in a space between the substrate and the plate.

22. (Currently amended) The ~~dry-etching~~ method for producing a solar cell according to claim 21, wherein:

the plate is placed to be spaced apart from the surface of the substrate by 5 to 30 mm.

23. (Currently amended) The ~~dry-etching~~ method for producing a solar cell according to claim 21, wherein:

the substrate is a plate or a film member made of one material selected from silicon, glass, metal, plastic and resin.

24. (Currently amended) The ~~dry-etching~~ method for producing a solar cell according to claim 21, wherein

the ~~dry-etching method is~~ fine textures are fabricated by a reactive ion etching method.

25. (Currently amended) A ~~dry-etching~~ method for ~~fabricating a substrate,~~ producing a solar cell comprising:

placing the ~~a~~ substrate for a solar cell on an RF electrode in a chamber;

placing a plate to cover the substrate, the plate being provided with a number of opening portions in a central region thereof and a number of opening portions in a peripheral region surrounding the central region thereof, an open area ratio of the opening portions in the peripheral region being smaller than an open area ratio of the opening portions in the central region;

wherein a number of ~~compounds~~ residues are formed by an etching of the substrate during an RF power applying, wherein the ~~compounds~~ residues are attached to the surface of the substrate.

26. (Currently amended) The ~~dry-etching~~ method for producing a solar cell according to claim 25, wherein

the plate is placed to be spaced apart from the surface of the substrate by 5 to 30 mm.

27. (Currently amended) The ~~dry-etching~~ method for producing a solar cell according to claim 25, wherein

the substrate is a plate or a film member made of one material selected from silicon, glass, metal, plastic and resin.

28. (Currently amended) The ~~dry-etching~~ method for producing a solar cell according to claim 1, comprising introducing a gas in a the chamber; and applying an RF power supply to said RF electrode.

29. (Currently amended) The ~~dry-etching~~ method for producing a solar cell according to claim 28, wherein

the ~~dry-etching method is~~ fine textures are fabricated by a reactive ion etching method.

30. (Currently amended) The ~~dry-etching~~ method for producing a solar cell according to claim 8, comprising introducing a gas in a the chamber; and applying an RF power supply to said RF electrode.

31. (Currently amended) The ~~dry-etching~~ method for producing a solar cell according to claim 15, comprising  
introducing a gas in a the chamber; and  
applying an RF power supply to said RF electrode.

32. (Currently amended) The ~~dry-etching~~ method for producing a solar cell according to claim 1, wherein the central region of the plate is opposed to a central region of the substrate, and the peripheral region of the plate is opposed to a peripheral region of the substrate.